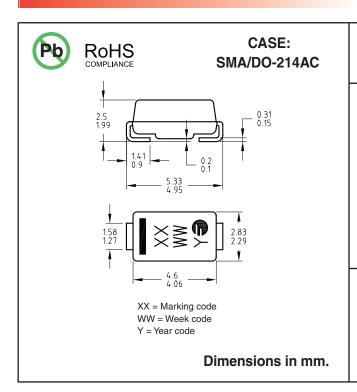


1.0 Amp. Surface Mount Low VF Schottky Barrier Rectifiers



VoltageCurrent20 V to 40 V1.0 A

- For surface mounted application
- Metal to silicon juction, majority carrier conduction
- Low forward voltage drop
- Easy pick and place
- High surge current capability
- Plastic material used carriers Underwraiters Laboratory Classification 94V-0
- Epitaxial construction
- High temperature soldering:
 260 °C / 10 seconds at terminals

MECHANICAL DATA

Case: Molded plastic

Terminals: Pure tin plated, lead free. Polarity: Indicated by cathode band

Packaging: 12 mm tape per EIA-STD RS-481.

Weight: 0.064 gram

Maximum Ratings and Electrical Characteristics at 25 °C

		FSSL12	FSSL13	FSSL14
Marking code		1A	1B	1C
V _{RRM}	Maximum Recurrent Peak Reverse Voltage (V)	20	30	40
V _{RMS}	Maximum RMS Voltage (V)	14	21	28
V_{DC}	Maximum DC Blocking Voltage (V)	20	30	40
I _{F(AV)}	$\begin{array}{c} \text{Maximum Average Forward Rectified Current at} \\ T_L \text{ (See graphic)} \end{array}$		1.0 A	
I _{FSM}	Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC Method)	50 A		
Tj	Operating Temperature Range	-55°C to +125°C		
T _{stg}	Storage Temperature Range	-55°C to +150°C		

Electrical Characteristics at Tamb = 25 °C

V _F	Maximum Instantaneous Forward Voltage (Note 1) @ 1.0 A	0.39 V
I _R	Maximum DC Reverse Current @ T _A = 25 °C	0.2 mA
	at Rated DC Blocking Voltage @ T _A =100°C	50 mA
R _{th (j-l)} R _{th (j-a)}	Typical Thermal Resistance (Note 2)	28 °C/W 88 °C/W

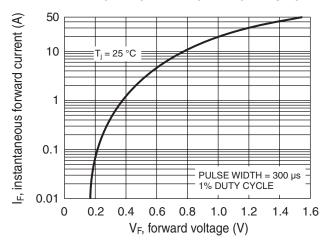
NOTES: 1. Pulse Test With PW = 300 μ sec, 1% Duty Cycle

2. Measured on P.C. Board with 5mm x 5mm Copper Pad Areas.

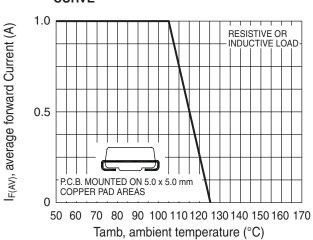


Rating And Characteristic Curves

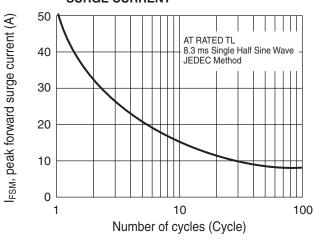
TYPICAL FORWARD CHARACTERISTIC



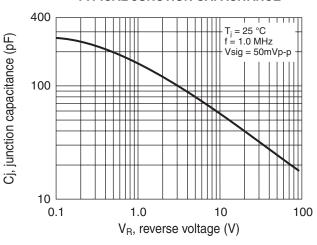
MAXIMUM FORWARD CURRENT DERATING CURVE



MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT



TYPICAL JUNCTION CAPACITANCE



TYPICAL REVERSE CHARACTERISTIC

